

General Description

The MC33063ADR2G is a monolithic control circuit containing the primary functions required for DC-to-DC converters. This device consists of an internal temperature compensated reference (1.25V), comparator, controlled duty cycle oscillator with an active current limit circuit, driver and high current output switch. The IC is specifically designed to be used in Step-Down and Step-Up and Voltage-Inverting applications with a minimum number of external components.

The MC33063ADR2G is available in DIP-8 and SOP-8(SOIC-8) package.



Features

- Operation from 3.0V to 40V Input
- Low Standby Current
- Current Limiting
- Output Switch Current to 1.5A
- Output Voltage Adjustable
- Frequency Operation to 100kHz

Functional Block Diagram

• Precision 2% Reference

Applications

- Battery Chargers
- NICs / Switches / Hubs
- ADSL Modems
- Negative Voltage Power Supplies



Shenzhen HuaXuanYang Electronics CO.,LTD



Pin Configuration



Pin Description

Pin Number	Pin Name	Function Description	Pin Number	Pin Name	Function Description
1	SC	Switch collector	5	FB	Comparator inverting input
2	SE	Switch emitter	6	V _{cc}	Input voltage
3	СТ	Timing capacitor	7	lpk	lpk sense
4	GND	Ground	8	DC	Drive collector

Absolute Maximum Ratings (Ta=25°C)

Parameter Name	Symbol	Value	Unit	
Power Supply Voltage		Vcc	40	V
Comparator Input Voltage Range		V _{IR}	-0.3~40	V
Switch Collector Voltage		Vc(switch)	c(switch) 40	
Switch Emitter Voltage (VPin1=40V)		V _E (switch)	40	V
Switch Collector to Emitter Voltage		V _{CE} (switch)	40	V
Driver Collector Voltage		Vc(drive)	40	V
Driver Collector Current		Ic(drive)	100	mA
Switch Current		I _{SW}	1.5	А
Power Dissinction	DIP-8	D	1.25	W
	SOP-8(SOIC-8)		625	mW
Operating Ambient Temperature Range		Та	-0~70	°C
Storage Temperature Range		Tstg	-65~150	°C



Parameter Name	Symbol	Min	Тур	Max	Unit
OSCILLATOR					
Frequency (Vpin5=0V,CT=1.0nF, Ta=25°C)	fosc	24	33	42	kHz
Charge Current (Vcc=5.0~40V, Ta=25°C)	lchg	24	35	42	μA
Discharge Current (Vcc=5.0~40V, Ta=25°C)	Idischg	140	220	260	μA
Discharge to Charge Current Ratio	ldischg/lchg	5.2	6.5	7.5	
(Pin7 to Vcc, Ta=25°C)					
Current limit Sense Voltage)/ink(conce)	250	300	350	mA
(Ichg=Idischg, Ta=25°C)	vipk(sense)				
OUTPUT SWITCH					
Saturation Voltage, Darlington Connection	V/. (cot)		1.0	10	V
(ISW=1.0A, Pins 1,8 Connected)	V _{CE} (Sal)		1.0	1.3	v
Saturation Voltage, Darlington Connection	V. (cot)	0.45	0.45	0.7	V
(ISW=1.0A, Rpin 8=82 Ω to Vcc, Forced $\beta \approx 20$)	v _{CE} (Sat)		0.40		
DC Current Gain (ISW=1.0A,VCE=5.0V, Ta=25°C)	hFE	50	75		
Collector Off-State Current (VCE=40V)	Ic(off)		0.01	100	μA
COMPARATOR					
Threshold Voltage (Ta=25°C)	\/tb	1.225	1.25	1.275	V
Threshold Voltage (Ta=0~70°C)	VII	1.21		1.29	v
Threshold Voltage Line Regulation	Poglino		1.4	5.0	m\/
(Vcc=3.0~40V)	Itegiine		1.4	5.0	IIIV
Input Bias Current(Vin=0V)	I _{IB}		-20	-400	nA
TOTAL DEVICE					
Supply Current (Vcc=5.0~40V, CT=1.0nF,	lee			10	m۸
Pin7=Vcc, Vpin5>Vth, pin2=Gnd, Remaining Pins Open)				4.0	ШA

Electrical Characteristics (Unless otherwise noted ,Vcc=5.0V, Ta=0~70°C)



Characteristics Curves











Typical Application

1. Step-Up Converter



Test	Conditions	Results	
Line Regulation	Vin=8.0V~16V, Io=175mA	30mV=±0.05%	
Load Regulation	Vin=12V,Io=75mA~175mA	10mV=±0.017%	
Output Ripple	Vin=12V, Io=175mA	400mVpp	
Efficiency	Vin=12V, Io=175mA	87.7%	
Output Ripple With Optional Filter	Vin=12V, Io=175mA	40mVpp	



2. Step-Down Converter



Test	Conditions	Results	
Line Regulation	Vin=15V~25V, Io=500mA	12mV=±0.12%	
Load Regulation	Vin=25V,Io=50mA~500mA	3.0mV=±0.03%	
Output Ripple	Vin=25V, Io=500mA	120mVpp	
Short Circuit Current	$Vin=25V, R_L=0.1\Omega$	1.1A	
Efficiency	Vin=25V, Io=500mA	83.7%	
Output Ripple With Optional Filter	Vin=25V, Io=500mA	40mVpp	



3. Voltage Inverting Converter



Test	Conditions	Results	
Line Regulation	Vin=4.5V~6.0V, Io=100mA	3.0mV=±0.012%	
Load Regulation	Vin=5.0V,Io=10mA~100mA	0.022V=±0.09%	
Output Ripple	Vin=5.0V, Io=100mA	500mVpp	
Short Circuit Current	$Vin=5.0V, R_L=0.1\Omega$	910mA	
Efficiency	Vin=5.0V, Io=100mA	62.2%	
Output Ripple With Optional Filter	Vin=5.0V, Io=100mA	70mVpp	



Application Information

Calculation	Step-Up	Step-Down	Voltage-Inverting
t _{on} /t _{off}	$\frac{V_{out} + V_F - V_{in(min)}}{V_{in(min)} - V_{sat}}$	$\frac{V_{out} + V_{F}}{V_{in(min)} - V_{sat} - V_{out}}$	$\frac{ V_{out} + V_F}{V_{in} - V_{sat}}$
(t _{on} + t _{off})	<u>1</u> f	<u>1</u> f	<u>1</u>
t _{off}	$\frac{t_{on} + t_{off}}{\frac{t_{on}}{t_{off}} + 1}$	$\frac{t_{on} + t_{off}}{\frac{t_{on}}{t_{off}} + 1}$	$\frac{t_{on} + t_{off}}{\frac{t_{on}}{\tau_{off}} + 1}$
ton	$(t_{on} + t_{off}) - t_{off}$	$(t_{on} + t_{off}) - t_{off}$	$(t_{on} + t_{off}) - t_{off}$
CT	4.0 x 10 ⁻⁵ t _{on}	4.0 x 10 ⁻⁵ t _{on}	4.0 x 10 ⁻⁵ t _{on}
I _{pk(switch)}	$2I_{out(max)}\left(\frac{t_{on}}{t_{off}} + 1\right)$	²¹ out(max)	$2I_{out(max)}\left(\frac{t_{on}}{t_{off}} + 1\right)$
R _{sc}	0.3/lpk(switch)	0.3/Ipk(switch)	0.3/Ipk(switch)
L _(min)	$\left(\frac{(V_{in(min)} - V_{sat})}{I_{pk(switch)}}\right)^{t}$ on(max)	$\left(\frac{(V_{in(min)} - V_{sat} - V_{out})}{I_{pk(switch)}}\right)^{t}$ on(max)	$\left(\frac{(V_{in(min)} - V_{sat})}{I_{pk(switch)}}\right) t_{on(max)}$
Co	9 <mark>lout^ton V_{ripple(pp)}</mark>	$\frac{I_{pk(switch)}(t_{on} + t_{off})}{8V_{ripple(pp)}}$	9 Vripple(pp)

Vsat = Saturation voltage of the output switch

V_F = Forward voltage drop of the output rectifier

The following power supply characteristics must be chosen:

Vin — Nominal input voltage

Vout — Desired output voltage , |
$$Vout$$
 |= 1.25 × (1 + $\frac{R2}{R1}$)

- lout Desired output current
- fmin Minimun desired output switching frequency at the selected values of Vin and Io
- Vripple(pp) Desired peak-to-peak output ripple voltage. In practice, the calculated capacitor value will need to be increased due to its equivalent series resistance and board layout. The ripple voltage should be kept to a low value since it will directly affect the line and load regulation.



DIP-8



SOP-8(SOIC-8)









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